

Solid State Relay OCMOS FET

PS7122A-1B,-2B,PS7122AL-1B,-2B

6, 8-PIN DIP, 250 V BREAK DOWN VOLTAGE, NORMALLY CLOSE TYPE 1-ch, 2-ch Optical Coupled MOS FET

DESCRIPTION

The PS7122A-1B, -2B and PS7122AL-1B, -2B are solid state relays containing GaAs LEDs on the light emitting side (input side) and normally close (N.C.) contact MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7122AL-1B, -2B have a surface mount type lead.

FEATURES

- 1 channel type (1 b output) or 2 channel type (1 b + 1 b output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small package (6, 8-pin DIP)
- · Low offset voltage
- PS7122AL-1B, -2B: Surface mount type
- UL approved: File No. E72422 (S)
- BSI approved: No. 8245/8246
- CSA approved: No. CA 101391

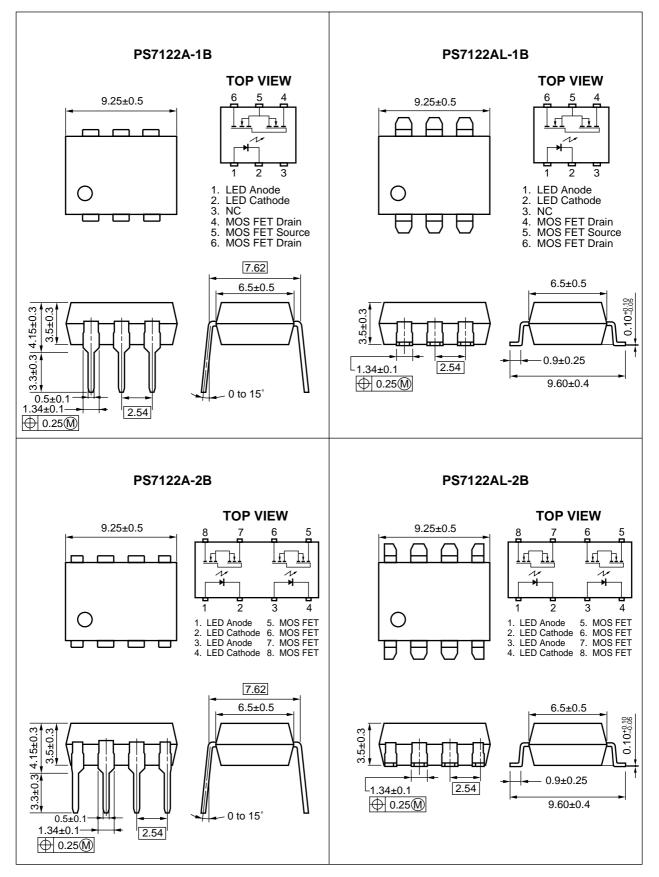
APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

The mark \star shows major revised points.





Data Sheet PN10274EJ01V1DS

Part Number	Package	Packing Style	Application Part Number *1
PS7122A-1B	6-pin DIP	Magazine case 50 pcs	PS7122A-1B
PS7122AL-1B			PS7122AL-1B
PS7122AL-1B-E3		Embossed Tape 1 000 pcs/reel	
PS7122AL-1B-E4			
PS7122A-2B	8-pin DIP	Magazine case 50 pcs	PS7122A-2B
PS7122AL-2B			PS7122AL-2B
PS7122AL-2B-E3		Embossed Tape 1 000 pcs/reel	
PS7122AL-2B-E4			

ORDERING INFORMATION (Solder Contains Lead)

*1 For the application of the Safety Standard, following part number should be used.

ORDERING INFORMATION (Pb-Free)

Part Number	Package	Packing Style	Application Part Number *1
PS7122A-1B-A	6-pin DIP	Magazine case 50 pcs	PS7122A-1B
PS7122AL-1B-A			PS7122AL-1B
PS7122AL-1B-E3-A		Embossed Tape 1 000 pcs/reel	
PS7122AL-1B-E4-A			
PS7122A-2B-A	8-pin DIP	Magazine case 50 pcs	PS7122A-2B
PS7122AL-2B-A			PS7122AL-2B
PS7122AL-2B-E3-A		Embossed Tape 1 000 pcs/reel	
PS7122AL-2B-E4-A			

*1 For the application of the Safety Standard, following part number should be used.

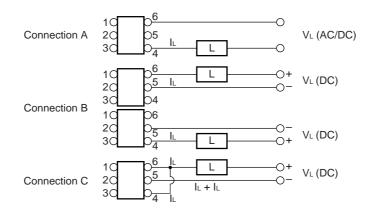
				Rati		
Parameter			Symbol	PS7122A-1B, PS7122AL-1B	PS7122A-2B, PS7122AL-2B	Unit
Diode	Forward Current (D	C)	lf	50		mA
	Reverse Voltage		VR	5.0		V
	Power Dissipation		PD	50		mW/ch
	Peak Forward Current *1			1		А
MOS FET	MOS FET Break Down Voltage		VL	250		V
	Continuous Connection A		١L	200		mA
	Load Current *2 Connection B			350	-	
	Connection C			500	-	
Pulse Load Current ^{*3} (AC/DC Connection)		Ilp	400		mA	
Power Dissipation			PD	560	375	mW/ch
Isolation Voltage *4			BV	1 500		Vr.m.s.
Total Power Dissipation			Р⊤	610	850	mW
Operating Ambient Temperature			TA	-40 to +85		°C
Storage Temperature			Tstg	-40 to +100		°C

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

...

*1 PW = 100 μs, Duty Cycle = 1 %

*2 Conditions: IF \geq 2 mA. The following types of load connections are available.



*3 PW = 100 ms, 1 shot

*4 AC voltage for 1 minute at $T_A = 25$ °C, RH = 60 % between input and output

RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)

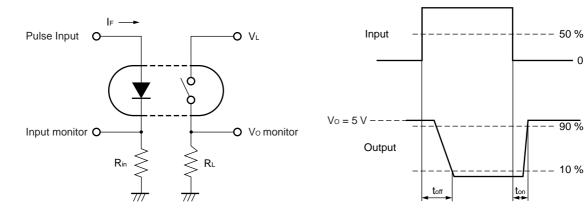
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

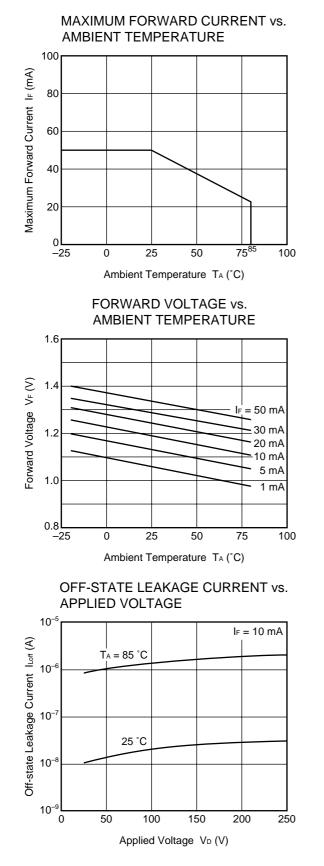
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	Ir	V _R = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	IF = 10 mA, VD = 250 V		0.03	1.0	μA
	Output Capacitance	Cout	IF = 10 mA, VD = 0 V, f = 1 MHz		340		pF/ch
Coupled	LED Off-state Current	Foff	I∟ = 200 mA			2.0	mA
	On-state Resistance	Ron1	I⊧ = 0 mA, I∟ = 10 mA		4.5	8.0	Ω
		Ron2	I_{F} = 0 mA, I_{L} = 200 mA, $t \leq$ 10 ms				
	Turn-on Time ^{*1}	ton	IF = 10 mA, Vo = 5 V, RL = 500 Ω,		0.04	0.2	ms
	Turn-off Time *1	toff	PW ≥ 10 ms		0.5	1.5	
	Isolation Resistance	R ⊦o	VI-O = 1.0 kVDC	10 ⁹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		1.1		pF/ch

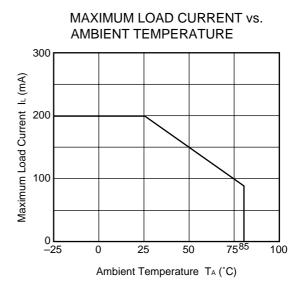
★

*1 Test Circuit for Switching Time

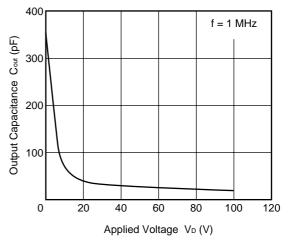


★ TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

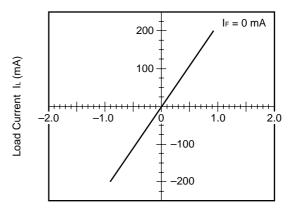






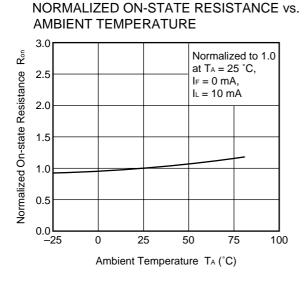


LOAD CURRENT vs. LOAD VOLTAGE

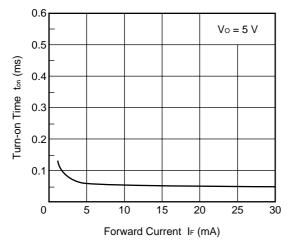


Load Voltage VL (V)

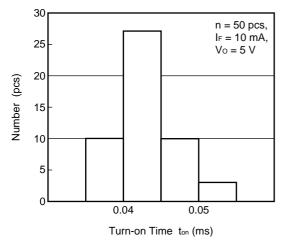
Data Sheet PN10274EJ01V1DS

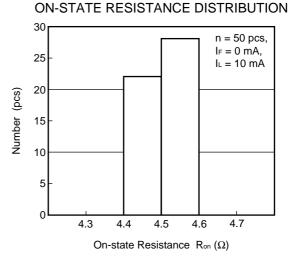


TURN-ON TIME vs. FORWARD CURRENT

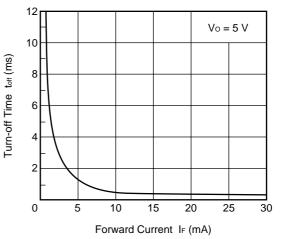


TURN-ON TIME DISTRIBUTION

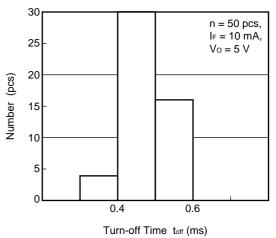


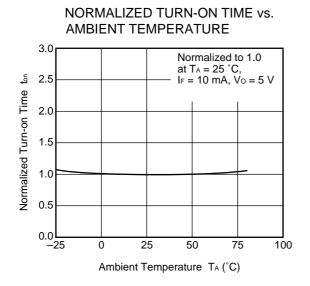


TURN-OFF TIME vs. FORWARD CURRENT

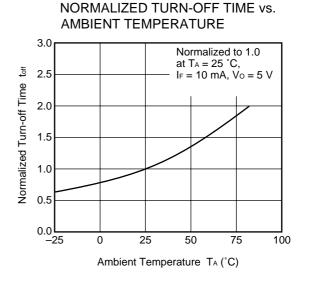


TURN-OFF TIME DISTRIBUTION

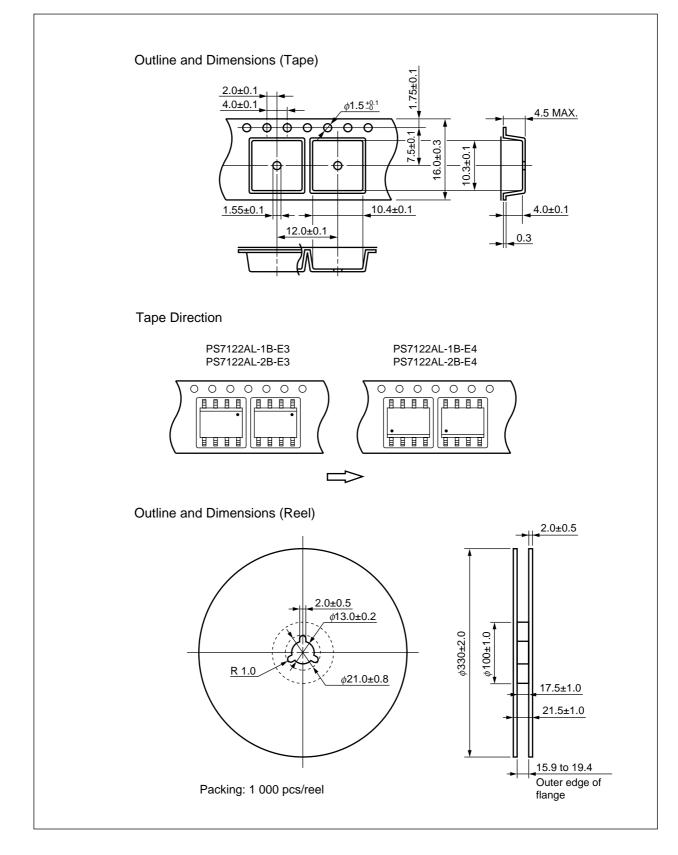




Remark The graphs indicate nominal characteristics.



* TAPING SPECIFICATIONS (in millimeters)

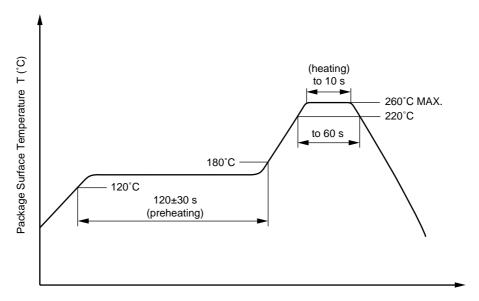


★ RECOMMENDED SOLDERING CONDITIONS

- (1) Infrared reflow soldering
 - Peak reflow temperature
 - Time of peak reflow temperature
 - Time of temperature higher than 220°C
 - Time to preheat temperature from 120 to 180°C
 - Number of reflows
 - Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
 One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.



Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
РВВ	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.

Important Information and Disclaimer: Information provided by CEL on its website or in other communications concerting the substance content of its products represents knowledge and belief as of the date that it is provided. CEL bases its knowledge and belief on information provided by third parties and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. CEL has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. CEL and CEL suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.